MOSFET – Power, Single, N-Channel 80 V, 5.5 mΩ, 89 A

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- These Devices are Pb-Free, Halogen Free/BFR Free, Beryllium Free and are RoHS Compliant

Typical Applications

- Synchronous Rectification
- AC-DC and DC-DC Power Supplies
- AC-DC Adapters (USB PD) SR
- Load Switch

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Beromotor Symbol Value III-it					11
Parameter		Symbol	Value	Unit	
Drain-to-Source Voltage		V _{DSS}	80	V	
Gate-to-Source Voltage		V _{GS}	±20	V	
Continuous Drain Current $R_{\theta JC}$ (Note 1)	Steady	$T_C = 25^{\circ}C$	۱ _D	89	A
Power Dissipation $R_{\theta JC}$ (Note 1)	State		P _D	104	W
Continuous Drain Current R _{θJA} (Notes 1, 2)	Steady State	T _A = 25°C	۱ _D	17	A
Power Dissipation $R_{\theta JA}$ (Notes 1, 2)	Olale		P _D	3.8	W
Pulsed Drain Current	$T_A = 25^{\circ}C$, $t_p = 10 \ \mu s$		I _{DM}	468	А
Operating Junction and Storage Temperature Range		T _J , T _{stg}	–55 to +175	°C	
Source Current (Body Diode)		۱ _S	87	А	
Single Pulse Drain–to–Source Avalanche Energy (I_{AV} = 5.9 A)		E _{AS}	465	mJ	
Lead Temperature Soldering Reflow for Solder- ing Purposes (1/8" from case for 10 s)		ΤL	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 1)	$R_{\theta JC}$	1.44	°C/W
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	40	

 The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

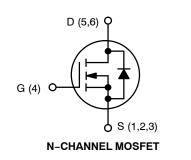
2. Surface-mounted on FR4 board using 1 in² pad size, 1 oz. Cu pad.

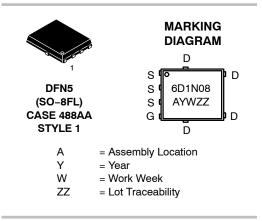


ON Semiconductor®

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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
80 V	5.5 m Ω @ 10 V	89 A
	8.0 mΩ @ 6 V	09 A





ORDERING INFORMATION

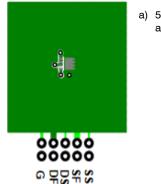
Device	Package	Shipping†
NTMFS6D1N08HT1G	DFN5 (Pb-Free)	1500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

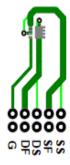
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A		80			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J	I_D = 250 µA, ref to 25°C			43.8		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	$T_J = 25^{\circ}C$			10	μA
		V _{DS} = 80 V	T _J = 125°C			100	
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS}	= 20 V			100	nA
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I _D =	= 120 μA	2.0		4.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J	I _D = 250 μA, ref to 25°C			-7.08		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D	= 20 A		4.5	5.5	mΩ
		V _{GS} = 6 V, I _D = 10 A			6.4	8.0	
Forward Transconductance	9 _{FS}	V _{DS} = 15 V, I _D = 20 A			80		S
Gate-Resistance	R _G	$T_A = 25^{\circ}C$			1.0		Ω
CHARGES & CAPACITANCES	-						-
Input Capacitance	C _{ISS}	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 40 V			2085		pF
Output Capacitance	C _{OSS}				300		
Reverse Transfer Capacitance	C _{RSS}				10		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 6 V, V_{DS} = 40 V, I_{D} = 30 A			10		nC
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 40 V, I_{D} = 30 A			32		nC
Gate-to-Source Charge	Q _{GS}				10		
Gate-to-Drain Charge	Q _{GD}				6		
Plateau Voltage	V _{GP}				5		V
SWITCHING CHARACTERISTICS (Note 3	3)						
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 10 V, V_{DS} = 64 V, I_{D} = 30 A, R_{G} = 2.5 Ω			18		ns
Rise Time	tr				50		
Turn-Off Delay Time	t _{d(OFF)}				48		1
Fall Time	t _f	1			39		1
DRAIN-SOURCE DIODE CHARACTERIS	STICS						
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 V,$	$T_J = 25^{\circ}C$		0.8	1.2	V
		I _S = 20 A	T _J = 125°C		0.7		
Reverse Recovery Time	t _{RR}	V_{GS} = 0 V, dI _S /dt = 100 A/µs, I _S = 20 A			49		ns
Reverse Recovery Charge	Q _{RR}				60		nC
Charge Time	t _a	$V_{GS} = 0 \text{ V, } dI_S/dt = 100 \text{ A}/\mu\text{s}, \\ I_S = 20 \text{ A}$			30		ns
Discharge Time	t _b				19		ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
Switching characteristics are independent of operating junction temperatures
R_{θJA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 × 1.5 in. board of FR-4 material. R_{θJC} is guaranteed by design while R_{θCA} is determined by the user's board design.



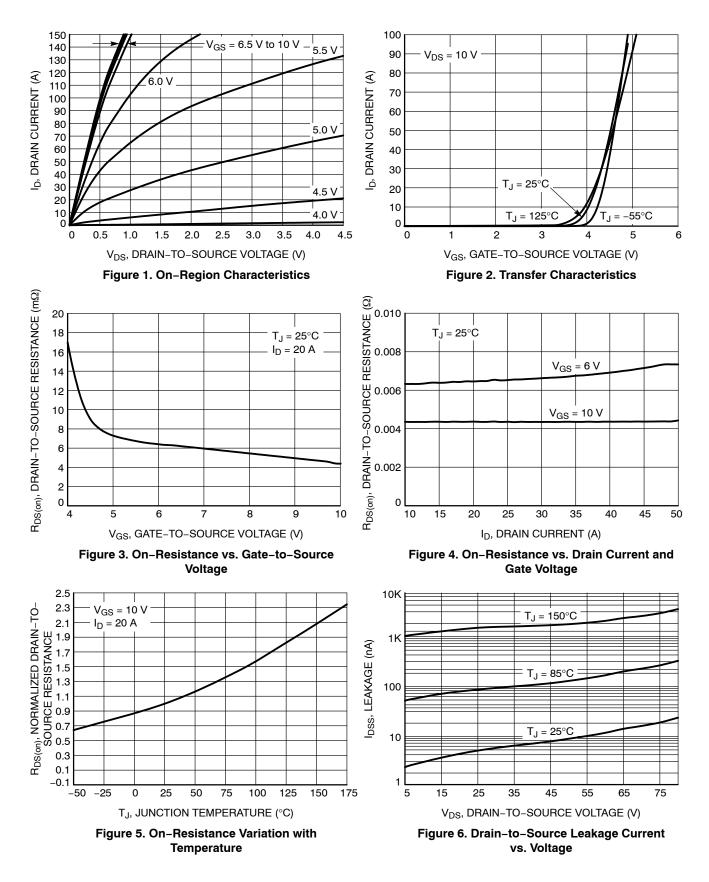
a) 53°C/W when mounted on a 1 in² pad of 2 oz copper.



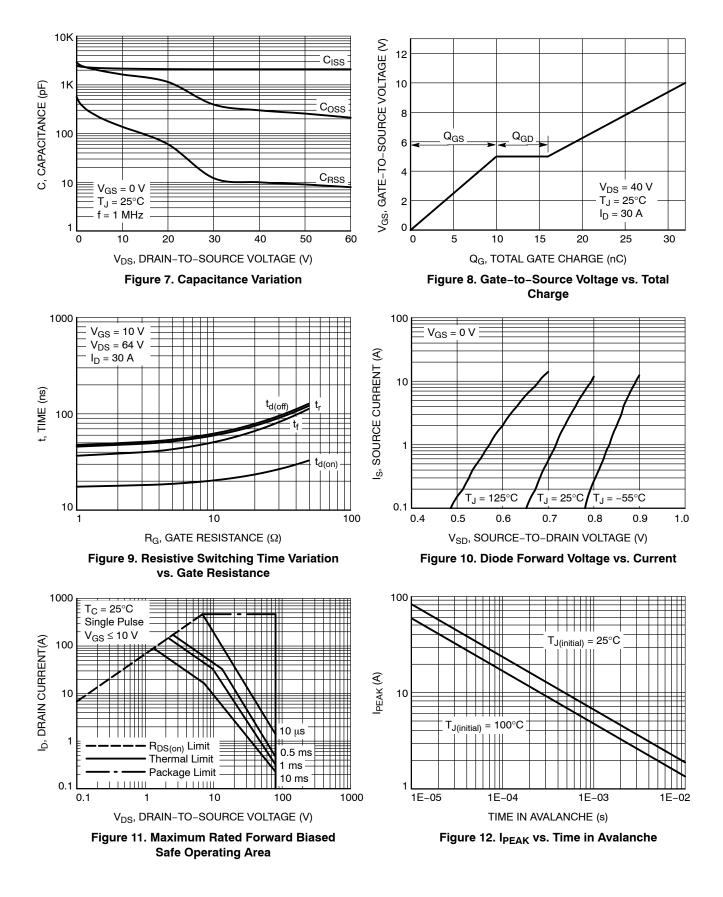
b) 125°C/W when mounted on a minimum pad of 2 oz copper.

- 5. Pulse Test: pulse width < 300 μ s, duty cycle < 2%. 6. E_{AS} of 465 mJ is based on started T_J = 25°C, I_{AS} = 5.9 A, V_{DD} = 80 V, V_{GS} = 10 V. 100% test at I_{AS} = 8.4 A. 7. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

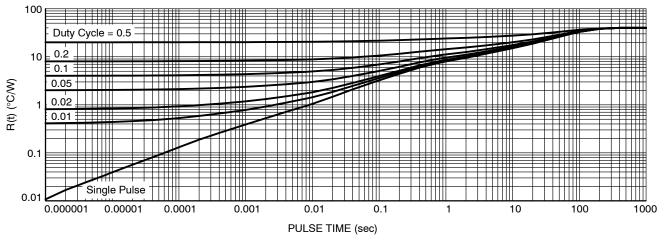


Figure 13. Thermal Characteristics





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